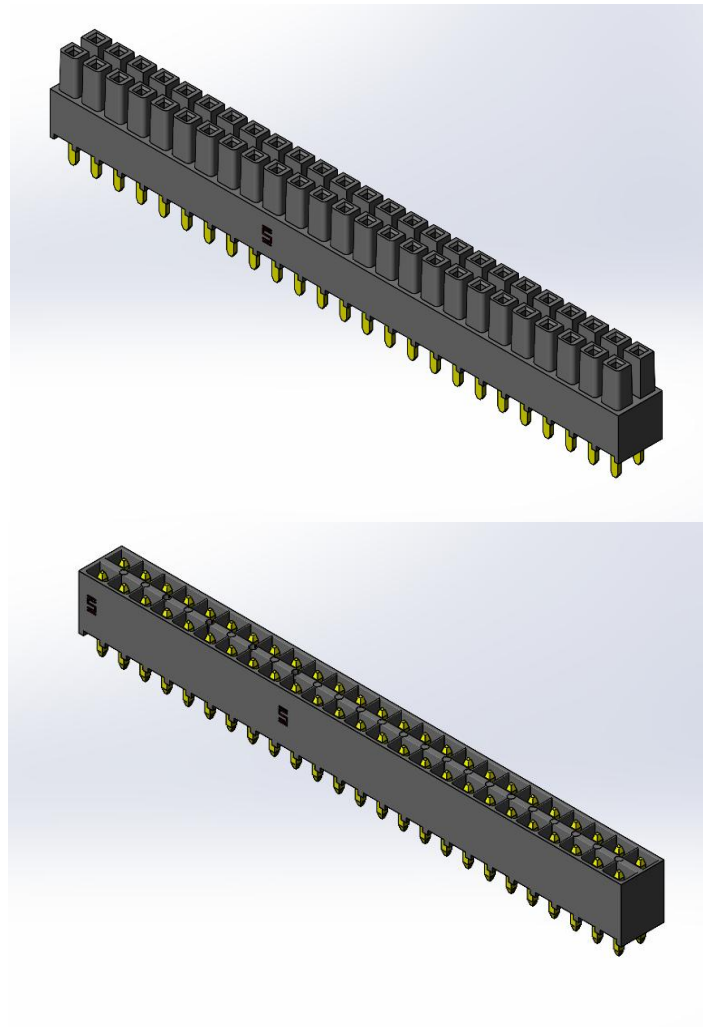




Project Number: Extended Life Product Test Report	Tracking Code: CR-1325206_Report_Rev_1
Requested by: Mark Shireman	Date: 9/17/2026
Part #: IPS1-125-01-S-D/ IPT1-125-01-S-D	
Part description: IPS1/IPT1	Tech: Danton Gan
Test Start: 3/25/2026	Test Completed: 9/15/2026



Extended Life Product Test Report

**IPS1/IPT1
IPS1-125-01-S-D/ IPT1-125-01-S-D**

Tracking Code: CR-1325206_Report_Rev_1	Part #: IPS1-125-01-S-D/ IPT1-125-01-S-D
Part description: IPS1/IPT1	

REVISION HISTORY

DATE	REV.NUM.	DESCRIPTION	ENG
9/17/2026	1	Initial Issue	DG

Tracking Code: CR-1325206_Report_Rev_1	Part #: IPS1-125-01-S-D/ IPT1-125-01-S-D
Part description: IPS1/IPT1	

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

To perform the following tests: Extended Life Product test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364.

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR testing were cleaned according to TLWI-0001.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free
- 9) Samtec Test PCBs used: PCB-114477-TST

FLOWCHARTS

Extended Life

Group 1

IPS1-125-01-S-D

IPT1-125-01-S-D

8 Assemblies

100 Cycles

Step	Description
1.	Plating Thickness Verification ⁽⁴⁾
2.	LLCR ⁽²⁾
3.	Cycles Quantity = 100 Cycles
4.	LLCR ⁽²⁾ Max Delta = 15 mOhm
5.	Thermal Shock ⁽⁵⁾
6.	LLCR ⁽²⁾ Max Delta = 15 mOhm
7.	Humidity ⁽¹⁾
8.	LLCR ⁽²⁾ Max Delta = 15 mOhm
9.	Photos ⁽³⁾

Group 2

IPS1-125-01-S-D

IPT1-125-01-S-D

8 Assemblies

250 Cycles

Step	Description
1.	Plating Thickness Verification ⁽⁴⁾
2.	LLCR ⁽²⁾
3.	Cycles Quantity = 250 Cycles
4.	LLCR ⁽²⁾ Max Delta = 15 mOhm
5.	Thermal Shock ⁽⁵⁾
6.	LLCR ⁽²⁾ Max Delta = 15 mOhm
7.	Humidity ⁽¹⁾
8.	LLCR ⁽²⁾ Max Delta = 15 mOhm
9.	Photos ⁽³⁾

(1) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(3) Photos

Attach 2-3 photos of contact area

(4) Plating Thickness Verification

Measure, verify, and document plating thickness on both male and female (one group only)

Plating thickness to be measured on loose pins used during assembly

(5) Thermal Shock = EIA-364-32

Exposure Time at Temperature Extremes = 1/2 Hour

Method A, Test Condition = I (-55°C to +85°C)

Test Duration = A-3 (100 Cycles)

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

- 1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors*.
- 2) Test Condition 1: -55°C to +85°C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stress in mated conditions.

HUMIDITY:

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors*.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stress in mated conditions.

LLCR:

- 6) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 7) A computer program, LLCR 221.exe, ensures repeatability for data acquisition.
- 8) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. <= +5.0 mOhms: -----Stable
 - b. +5.1 to +10.0 mOhms: -----Minor
 - c. +10.1 to +15.0 mOhms:-----Acceptable
 - d. +15.1 to +50.0 mOhms:-----Marginal
 - e. +50.1 to +1000 mOhms:-----Unstable
 - f. >+1000 mOhms: -----Open Failure

RESULTS**LLCR Extended Life Group (192 LLCR test points)****Group 1 –100 cycles**

- **Initial** -----4.13 mOhms Max
- **Durability, 100 Cycles**
 - **<= +5.0 mOhms** ----- 192 Points ----- Stable
 - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
 - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
 - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
 - **+50.1 to +2000 mOhms** -----0 Points ----- Unstable
 - **>+2000 mOhms** -----0 Points ----- Open Failure
- **Thermal Shock**
 - **<= +5.0 mOhms** ----- 192 Points ----- Stable
 - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
 - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
 - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
 - **+50.1 to +2000 mOhms** -----0 Points ----- Unstable
 - **>+2000 mOhms** -----0 Points ----- Open Failure
- **Humidity**
 - **<= +5.0 mOhms** ----- 192 Points ----- Stable
 - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
 - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
 - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
 - **+50.1 to +2000 mOhms** -----0 Points ----- Unstable
 - **>+2000 mOhms** -----0 Points ----- Open Failure

Group 2 –250 cycles

- **Initial** -----4.14 mOhms Max
- **Durability, 250 Cycles**
 - **<= +5.0 mOhms** ----- 192 Points ----- Stable
 - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
 - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
 - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
 - **+50.1 to +2000 mOhms** -----0 Points ----- Unstable
 - **>+2000 mOhms** -----0 Points ----- Open Failure
- **Thermal Shock**
 - **<= +5.0 mOhms** ----- 192 Points ----- Stable
 - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
 - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
 - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
 - **+50.1 to +2000 mOhms** -----0 Points ----- Unstable
 - **>+2000 mOhms** -----0 Points ----- Open Failure
- **Humidity**
 - **<= +5.0 mOhms** ----- 192 Points ----- Stable
 - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
 - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
 - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
 - **+50.1 to +2000 mOhms** -----0 Points ----- Unstable
 - **>+2000 mOhms** -----0 Points ----- Open Failure

DATA SUMMARIES

LLCR Extended Life Group

- 1). A total of 192 points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4). The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: -----Stable
 - b. $+5.1$ to $+10.0$ mOhms: -----Minor
 - c. $+10.1$ to $+15.0$ mOhms: -----Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: -----Marginal
 - e. $+50.1$ to $+2000$ mOhms: -----Unstable
 - f. $> +2000$ mOhms: -----Open Failure

Group 1-100 cycles

LLCR Measurement Summaries by Pin Type				
Date	2026/3/25	2026/3/26	2026/4/15	
Room Temp (Deg C)	23	23	23	
Rel Humidity (%)	50	50	50	
Technician	Danton Gan	Danton Gan	Danton Gan	
mOhm values	Actual	Delta	Delta	Delta
	Initial	100 Cycles	Therm Shck	Humidity
Pin Type: Signal 1				
Average	3.56	0.11	0.18	
St. Dev.	0.21	0.08	0.13	
Min	3.21	0	0	
Max	4.13	0.36	0.89	
Summary Count	192	192	192	
Total Count	192	192	192	

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	≤ 5	$> 5 \text{ \& } \leq 10$	$> 10 \text{ \& } \leq 15$	$> 15 \text{ \& } \leq 50$	$> 50 \text{ \& } \leq 1000$	> 1000
Cycles	192	0	0	0	0	0
Therm Shck	192	0	0	0	0	0

DATA SUMMARIES Continued

Group 2-250 cycles

LLCR Measurement Summaries by Pin Type				
Date	2026/3/25	2026/3/26	2026/4/15	
Room Temp (Deg C)	23	23	23	
Rel Humidity (%)	50	50	50	
Technician	Danton Gan	Danton Gan	Danton Gan	
mOhm values	Actual	Delta	Delta	Delta
	Initial	250 Cycles	Therm Shck	Humidity
Pin Type: Signal 1				
Average	3.52	0.15	0.19	
St. Dev.	0.22	0.15	0.16	
Min	2.46	0	0	
Max	4.14	0.91	0.92	
Summary Count	192	192	192	
Total Count	192	192	192	

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	<=5	>5 & <=10	>10 & <=15	>15 & <=50	>50 & <=1000	>1000
Cycles	192	0	0	0	0	0
Therm Shck	192	0	0	0	0	0

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EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: HZ-MO-05

Description: Micro-ohmmeter/Data Acquisition System

Manufacturer: Keithley

Model: 3706

Serial #: 1285188

Accuracy: Last Cal: 9/26/2025, Next Cal: 9/25/2026

Equipment #: HZ-THC-01

Description: Humidity transmitter

Manufacturer: Thermtron

Model: SM-8-8200

Serial #: 38846

Accuracy: Last Cal: 3/28/2026, Next Cal: 3/27/2027

Equipment #: HZ-TSC-01

Description: Vertical Thermal Shock Chamber

Manufacturer: Cincinnatti Sub Zero

Model: VTS-3-6-6-SC/AC

Serial #: 10-VT14994

Accuracy: See Manual

... Last Cal: 03/28/2026, Next Cal: 03/27/2027